

Marking Information

Site 1:



NE = Product Type Marking Code YM = Date Code Marking

Y = Year (ex: H = 2020) M = Month (ex: 9 = September)

Date Code Key

Ī	Year	2013	 2019	2020	2021	2022	2023	2024	2025	2026	2027	2028
ľ	Code	Α	 G	Н	I	J	K	L	М	N	0	Р

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

Site 2:



NE = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: H = 2020)

W = Week (ex: a = week 27; z represents week 52 and 53) X = Internal code (ex: U = Monday)

Date Code Key

Ī	Year	2020	2021	2022	2023	2024	2025	2026	2027	2028
	Code	0	1	2	3	4	5	6	7	8

W	/eek	1-26	27-52	53
C	ode	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	Т	U	V	W	Х	Υ	Z



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	40	V		
Gate-Source Voltage			V_{GSS}	±20	V
Continuous Prain Current (Note 6) / = 10)/	Steady State	T _A = +25°C T _A = +70°C	l _D	8.0 6.3	Α
Continuous Drain Current (Note 6) V _{GS} = 10V	t < 10s	T _A = +25°C T _A = +70°C	l _D	9.5 7.5	Α
Continuous Drain Current (Note 6) V _{GS} = 4.5V	I _D	6.7 5.3	А		
Continuous Diain Current (Note 6) VGS - 4.5V	I_{D}	8.0 6.4	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I _{DM}	32	Α		
Maximum Body Diode Continuous Current		Is	2.5	А	

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)	T _A = +25°C	D	0.66	W	
Total Power Dissipation (Note 5)	T _A = +70°C	P_{D}	0.42		
Thermal Resistance, Junction to Ambient (Note 5)	Steady State		189	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t < 10s	$R_{\theta JA}$	132	C/VV	
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	P_{D}	2.03	W	
Total Fower Dissipation (Note o)	T _A = +70°C	FD	1.31	v V	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	61		
Thermal Resistance, Junction to Ambient (Note o)	$R_{\theta JA}$	43	°C/W		
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	9.3			
Operating and Storage Temperature Range	$T_{J_i} T_{STG}$	-55 to +150	°C		

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	40	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	1	μΑ	V _{DS} = 40V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	-	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	1.4	_	2.4	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance	J		15	20	mΩ	$V_{GS} = 10V, I_D = 8A$
Static Diani-Source On-Nesistance	R _{DS(ON)}		20	28	11122	$V_{GS} = 4.5V, I_D = 4A$
Diode Forward Voltage	V_{SD}		0.7	1	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	1	1060	_	pF	.,
Output Capacitance	Coss	I	84		рF	$V_{DS} = 20V, V_{GS} = 0V,$ -f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}		58		pF	1 - 1.01/1112
Gate Resistance	R_g	-	1.6	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg		8.8		nC	
Total Gate Charge (V _{GS} = 10V)	Qg	_	19.1	_	nC	\/ - 20\/ I - 0A
Gate-Source Charge	Q _{gs}	_	3.0	_	nC	$V_{DS} = 20V, I_D = 8A$
Gate-Drain Charge	Q_{gd}	_	2.5	_	nC	
Turn-On Delay Time	t _{D(ON)}	_	5.3	_	ns	
Turn-On Rise Time	t _R	_	7.1	_	ns	$V_{DS} = 20V, R_L = 2.5\Omega$
Turn-Off Delay Time	t _{D(OFF)}	_	15.1	_	ns	V_{GS} = 10V, R_G = 3 Ω
Turn-Off Fall Time	t _F	_	4.8	_	ns]
Reverse Recovery Time	t _{RR}		10.5	_	ns	L = 9.4 di/dt = 1004/up
Reverse Recovery Charge	Q _{RR}		4.15	_	nC	$I_F = 8A$, di/dt = 100A/ μ s

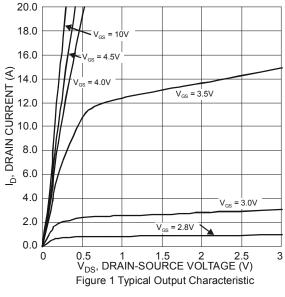
Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

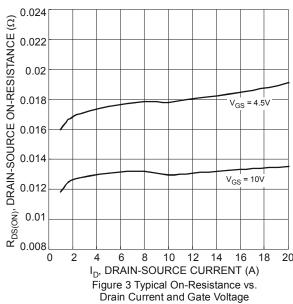
^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

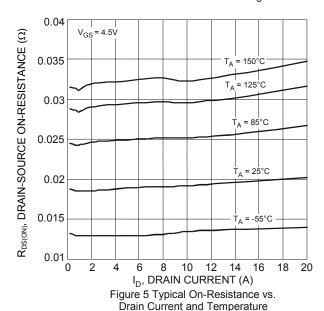
^{7.} Short duration pulse test used to minimize self-heating effect.

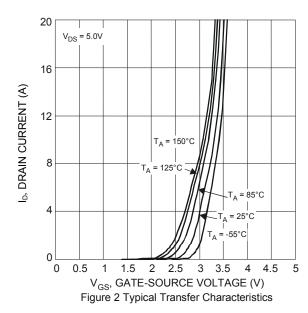
^{8.} Guaranteed by design. Not subject to production testing.

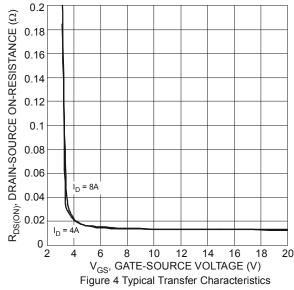












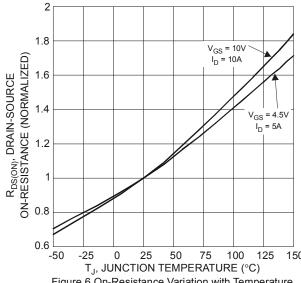
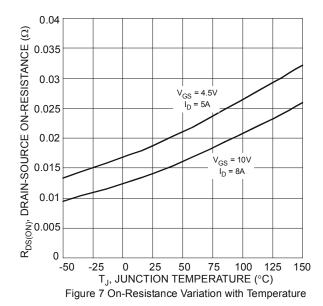
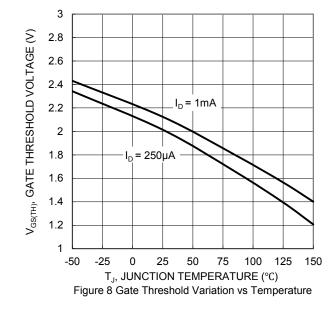
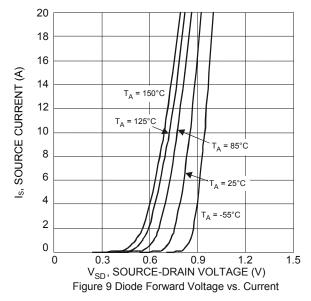


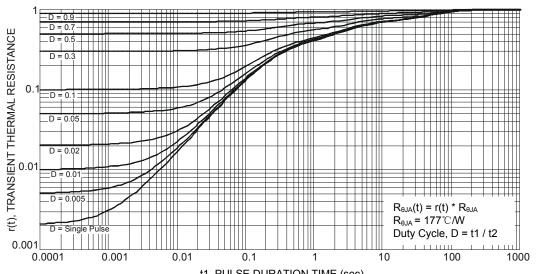
Figure 6 On-Resistance Variation with Temperature











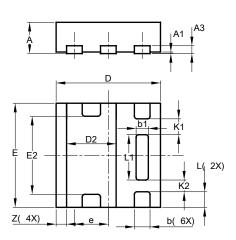
t1, PULSE DURATION TIME (sec) Figure 10 Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type E)

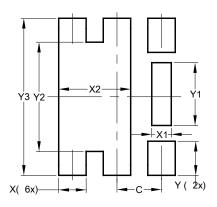


	U-DFN2020-6							
Type E								
Dim								
Α	0.57	0.63	0.60					
A1	0	0.05	0.03					
A3	_	-	0.15					
b	0.25	0.35	0.30					
b1	0.185	0.285	0.235					
D	1.95	2.05	2.00					
D2	0.85	1.05	0.95					
Е	1.95	2.05	2.00					
E2	1.40	1.60	1.50					
е	_	-	0.65					
L	0.25	0.35	0.30					
L1	0.82	0.92	0.87					
K1	_	_	0.305					
K2	0.225							
Z – – 0.20								
All	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6 (Type E)



Dimensions	Value (in mm)
С	0.650
X	0.400
X1	0.285
X2	1.050
Y	0.500
Y1	0.920
Y2	1.600
Y3	2 300

March 2020



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